



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Features

- **Single channel pin compatible population option for Le9662 or Le9672 two channel, 100 V maximum battery designs**
 - Lower overall costs by producing a single design with a 1 or 2 channel assembly option
- **Highly-integrated, low power, cost-effective voice solution, enabling reduced BOM costs**
- **Single port 4-wire interface control (ZSI)**
 - Compatible with numerous VoIP processors and SoC solutions
 - Less expensive isolation than multi-port control
 - Simplifies board routing
- **VoicePath SDK and VP-API-II Software available to implement FXS functions**
- **VeriVoice Professional Test Suite Software**
 - Comprehensive subscriber loop testing, including *Telcordia GR-909-CORE / TIA-1063* diagnostic testing
 - Industry leading advanced test software
- **VeriVoice Manufacturing Test Package (VVMT)**
 - Facilitates factory testing and calibration of assembled boards
- **Low cost, energy efficient switching regulator architectures, satisfying V5.0 European Code of Conduct on Energy Consumption of Broadband Equipment**
 - Up to 65 V_{RMS} open circuit ringing with up to 5 REN load
- **Low cost, 2-Layer PCB Reference Designs**
- **Complete Wideband BORSCHT functionality**
- **Worldwide Programmability**
- **Narrowband or Wideband operation**

Applications

- **VDSL2 Residential Gateways and Integrated Access Devices (IADs)**
- **Docsis 3.0 Cable Embedded Multimedia Terminal Adapters (eMTAs)**
- **PON Single Family Units (SFU)**
- **GPON and EPON Fiber-to-the-premise (FTTX) solutions**

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Version 1

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Ordering Information

Device OPN	Device Type	Package	Packing
Le9661WQCT	SLIC, Tracker	56-pin QFN	Tape&Reel
Le9661WQC	SLIC, Tracker	56-pin QFN	Tray

These Green packages meet RoHS 2 Directive 2011/65/EU of the European Council to minimize the environmental impact of electrical equipment.

Description

The miSLIC™ Line Circuits together with a ZSI enabled VoIP processor or SoC, provides an economical turn-key solution for derived voice applications. The miSLIC devices are controlled by a VoIP processor or SoC through a simple, single serial interface.

The Le9661 miSLIC 1 FXS Tracking device is a drop-in pin compatible device to the miSLIC 2 FXS Le9662 FBABS or Le9672 Tracker devices. The Le9661 uses energy efficient power supply topologies for reduced BOM cost. The Le9661 can be configured to operate a flyback full tracking supply or an inverting buck-boost fixed tracking supply. Ringing and system power management are supported to limit the peak power requirements of the telephone line FXS port. The Le9661 features wideband clarity and complete BORSCHT functionality.

Manufacturing self test and subscriber line diagnostics are available features. All AC, DC, and power parameters are programmable making the Le9661 device suitable for any short loop application requiring SLIC functionality.

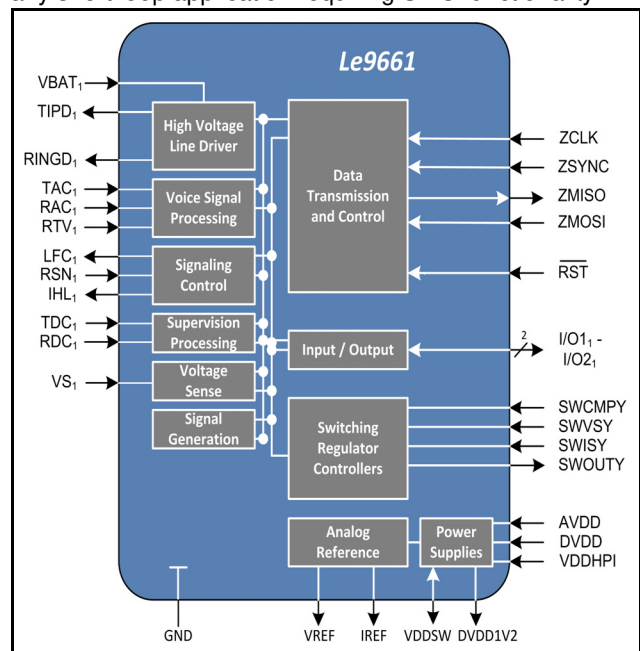


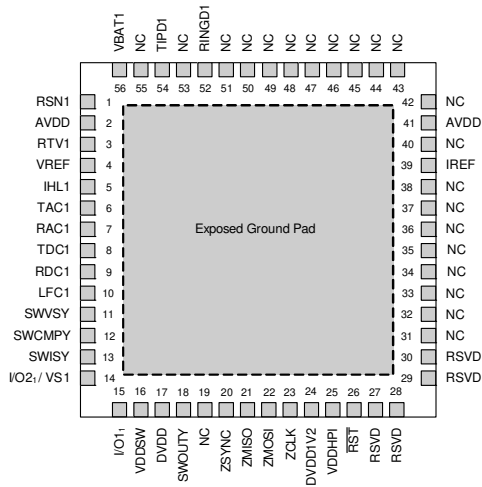
Figure 1 - Le9661 Block Diagram

Selected Electrical Specifications

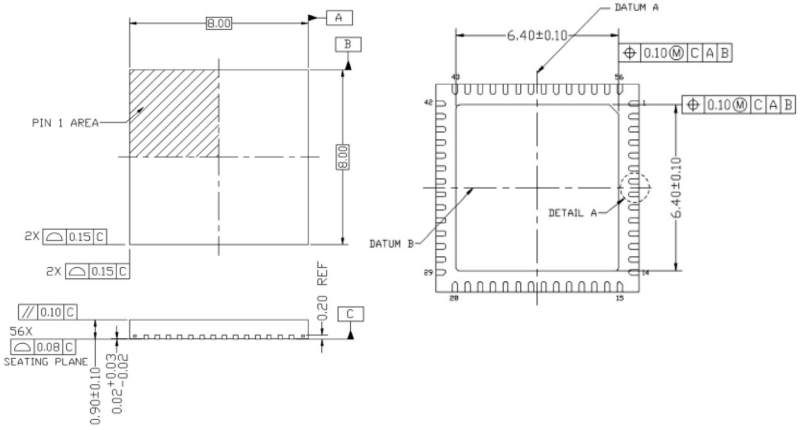
Description	Symbol	Test Conditions	Min	Typ	Max	Unit
Ambient Temperature, under Bias	T_A		-40		+85	°C
Digital and Analog Supply Voltages	DVDD, AVDD		3.135	3.3	3.465	V_{DC}
Operating Limits: V_{BAT1} (in active state)			-105 V_{DC} to -12 V_{DC}			V_{DC}
Line Current: Buck-boost operation Flyback operation	I_{LA}		18 18	25 25	30 45	mA
Ringing Voltage	V_{RING}	5REN		50	65	V_{RMS}
Two-Wire Return Loss	R_L	200 to 3400 Hz		30		dB
Longitudinal Balance		1 kHz		58		dB
Device Power Dissipation, Continuous	$P_{D(max)}$	$T_A = 85^\circ C$		2		W
Junction to Ambient Thermal Resistance	θ_{JA}			27		°C/W

Device Power Consumption	Symbol	Test Conditions	Typ	Unit
Shutdown	P_D	Switcher off	8	mW
Disconnect			37	
Low Power Idle Mode		On-Hook	52	
Idle		On-Hook	98	
Active		Off-Hook, 300 Ω , $I_{LA} = 25$ mA	324	
Ringing		50 V_{RMS} , 1REN	462	

Device Pinout



Package Drawings



Related Collateral

- *Le9661 Tracking Battery miSLIC™ Line Circuit Preliminary Data Sheet*, Document ID# 148233
- *Le9662 Shared Battery Dual miSLIC™ Line Circuit Preliminary Data Sheet*, Document ID# 146852
- *Le9672 Tracking Battery Dual miSLIC™ Line Circuit Preliminary Data Sheet*, Document ID# 146853